

$V_{RSM}$ $V_{RRM}$ V	$I_D$ ( $T_h = 80^\circ\text{C}$ )	
	68 A	96 A
800	SK 70 B 08	SK 95 D 08
1200	SK 70 B 12	SK 95 D 12
1600	SK 70 B 16	SK 95 D 16

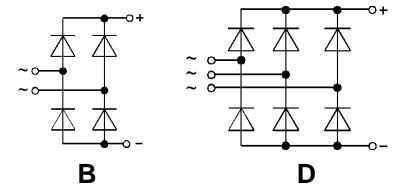
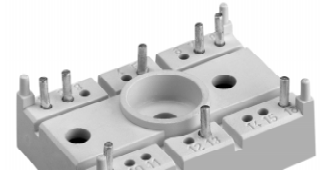
## SEMITOP® 2

### Bridge Rectifier

### SK 70 B SK 95 D

#### Preliminary Data

Symbol	Conditions	SK 70 B	SK 95 D	Units
$I_D$	$T_h = 80^\circ\text{C}$	68	96	A
$I_{FSM}$ $i^2t$	$T_{vj} = 25^\circ\text{C}; 10\text{ ms}$	–	–	A
	$T_{vj} = 125^\circ\text{C}; 10\text{ ms}$	750	–	A
	$T_{vj} = 25^\circ\text{C}; 8,3...10\text{ ms}$	–	–	$\text{A}^2\text{s}$
	$T_{vj} = 125^\circ\text{C}; 8,3...10\text{ ms}$	–	–	$\text{A}^2\text{s}$
$V_F$	$T_{vj} = 25^\circ\text{C}; (I_T = 35\text{ A}); \text{max.}$	1,1	–	V
$V_{(T0)}$	$T_{vj} = 125^\circ\text{C}$	0,8	–	V
$r_T$	$T_{vj} = 125^\circ\text{C}$	11	–	$\text{m}\Omega$
$I_{RD}$	$T_{vj} = 125^\circ\text{C}; V_{RD} = V_{RRM}$	–	–	mA
$R_{thjh}$	per diode	1,2	1,2	K/W
	per module	0,3	0,2	K/W
$T_{vj}$		- 40 ... + 125		$^\circ\text{C}$
$T_{st}$		- 40 ... + 125		$^\circ\text{C}$
$T_{solder}$	terminals, 10 s	260		$^\circ\text{C}$
$V_{isol}$ $M_1$ w	a.c. 50 Hz; r.m.s. 1 s/1 min	3000 / 2500		V
	case to heatsink	2,0		Nm
	SI units	17,6		lb.in.
	US units	–		g
Case		T 7		



#### Features

- Compact Design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- Up to 1600V reverse voltage
- High surge currents
- Glass passivated diode chips

#### Typical Applications

- Input rectifier for power supplies
- Rectifier

Case → B 17 – 22

